

Benoit CAPITAINE Technicien ENS LYON mai 2015

ACCEL BOARD

All Mikroelektronika's development systems feature a large number of peripheral modules expanding microcontroller's range of application and making the process of program testing easier. In addition to these modules, it is also possible to use numerous additional modules linked to the development system through the I/O port connectors. Some of these additional modules can operate as stand-alone devices without being connected to the microcontroller.

Manual

Additional Board



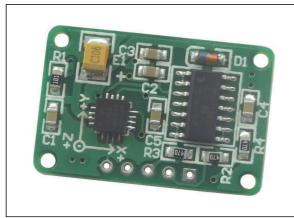
SOFTWARE AND HARDWARE SOLUTIONS FOR EMBEDDED WORLD ... making it simple

ACCEL Board

The Accel Board is an additional board used to measure the force of gravity and acceleration, to detect rotation, etc.

Key features:

- 3-axis sensing;
- Power supply voltage 5V DC; and
- Low-power consumption.



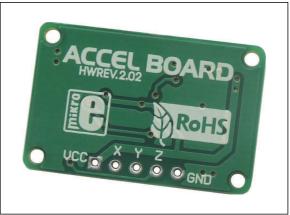
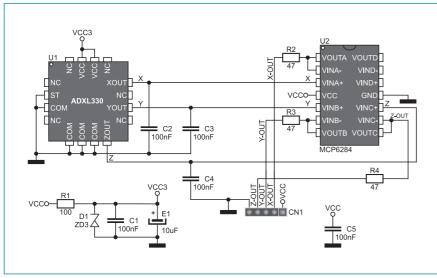


Figure 2: Back side of the Accel Board

Figure 1: Accel Board

How to connect the board?

The Accel Board is connected to the microcontroller or some other device via pads. To make the connection easy all the pads are clearly marked on the back of the board.



The function of the additional board's pins:

- X axis output
- Y axis output
- X Y Z VCC
- Z axis output5V DC power supply voltage
- GND Ground

MikroElektronika

Figure 3: Accel Board connection schematic

ANALOG DEVICES

Small, Low Power, 3-Axis ±3 g iMEMS® Accelerometer

ADXL330

FEATURES

3-axis sensing Small, low-profile package 4 mm × 4 mm × 1.45 mm LFCSP Low power 200 μA at V₅ = 2.0 V (typical) Single-supply operation 2.0 V to 3.6 V 10,000 g shock survival Excellent temperature stability BW adjustment with a single capacitor per axis RoHS/WEEE lead-free compliant

APPLICATIONS

Cost-sensitive, low power, motion- and tilt-sensing applications Mobile devices

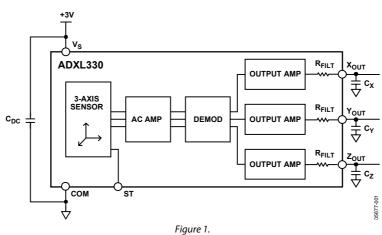
- Gaming systems
- Disk drive protection
- Image stabilization Sports and health devices

GENERAL DESCRIPTION

The ADXL330 is a small, thin, low power, complete three axis accelerometer with signal conditioned voltage outputs, all on a single monolithic IC. The product measures acceleration with a minimum full-scale range of ± 3 g. It can measure the static acceleration of gravity in tilt-sensing applications, as well as dynamic acceleration resulting from motion, shock, or vibration.

The user selects the bandwidth of the accelerometer using the C_x , C_y , and C_z capacitors at the X_{OUT} , Y_{OUT} , and Z_{OUT} pins. Bandwidths can be selected to suit the application, with a range of 0.5 Hz to 1,600 Hz for X and Y axes, and a range of 0.5 Hz to 550 Hz for the Z axis.

The ADXL330 is available in a small, low-profile, 4 mm \times 4 mm \times 1.45 mm, 16-lead, plastic lead frame chip scale package (LFCSP_LQ).



FUNCTIONAL BLOCK DIAGRAM

Rev. 0

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

 One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.

 Tel: 781.329.4700
 www.analog.com

 Fax: 781.461.3113
 ©2006 Analog Devices, Inc. All rights reserved.

TABLE OF CONTENTS

Features 1
Applications1
General Description
Functional Block Diagram 1
Revision History
Specifications
Absolute Maximum Ratings 4
ESD Caution
Pin Configuration and Function Descriptions
Typical Performance Characteristics
Theory of Operation11
Mechanical Sensor11

Performance11
Applications12
Power Supply Decoupling 12
Setting the Bandwidth Using Cx, Cy and Cz12
Self-Test 12
Design Trade-Offs for Selecting Filter Characteristics: The Noise/BW Trade-Off12
Use with Operating Voltages Other than 3 V 12
Axes of Acceleration Sensitivity
Outline Dimensions14
Ordering Guide14

REVISION HISTORY

3/06—Revision 0: Initial Version

SPECIFICATIONS

 $T_A = 25^{\circ}C$, $V_S = 3 V$, $C_X = C_Y = C_Z = 0.1 \mu F$, acceleration = 0 g, unless otherwise noted. All minimum and maximum specifications are guaranteed. Typical specifications are not guaranteed.

Parameter	Conditions	Min	Тур	Max	Unit
SENSOR INPUT	Each axis				
Measurement Range		±3	±3.6		g
Nonlinearity	% of full scale		±0.3		%
Package Alignment Error			±1		Degrees
Inter-Axis Alignment Error			±0.1		Degrees
Cross Axis Sensitivity ¹			±1		%
SENSITIVITY (RATIOMETRIC) ²	Each axis				
Sensitivity at Xout, Yout, Zout	$V_s = 3 V$	270	300	330	mV/ <i>g</i>
Sensitivity Change Due to Temperature ³	$V_s = 3 V$		±0.015		%/°C
ZERO g BIAS LEVEL (RATIOMETRIC)	Each axis				
0 g Voltage at Xout, Yout, Zout	$V_S = 3 V$	1.2	1.5	1.8	V
0 g Offset vs. Temperature			±1		m <i>g</i> /°C
NOISE PERFORMANCE					
Noise Density Xout, Yout			280		µg/√Hz rms
Noise Density Zout			350		µg/√Hz rms
FREQUENCY RESPONSE ⁴					
Bandwidth Xout, Yout ⁵	No external filter		1600		Hz
Bandwidth Zout ⁵	No external filter		550		Hz
R _{FILT} Tolerance			32 ± 15%		kΩ
Sensor Resonant Frequency			5.5		kHz
SELF-TEST ⁶					
Logic Input Low			+0.6		V
Logic Input High			+2.4		V
ST Actuation Current			+60		μA
Output Change at XOUT	Self-test 0 to 1		-150		mV
Output Change at Yout	Self-test 0 to 1		+150		mV
Output Change at ZOUT	Self-test 0 to 1		-60		mV
OUTPUT AMPLIFIER					
Output Swing Low	No load		0.1		V
Output Swing High	No load		2.8		V
POWER SUPPLY					
Operating Voltage Range		2.0		3.6	V
Supply Current	$V_S = 3 V$		320		μΑ
Turn-On Time ⁷	No external filter		1		ms
TEMPERATURE					
Operating Temperature Range		-25		+70	°C

¹ Defined as coupling between any two axes.

² Sensitivity is essentially ratiometric to V_s.

³ Defined as the output change from ambient-to-maximum temperature or ambient-to-minimum temperature.

⁴ Actual frequency response controlled by user-supplied external filter capacitors (C_x, C_y, C_z). ⁵ Bandwidth with external capacitors = $1/(2 \times \pi \times 32 \text{ k}\Omega \times \text{C})$. For C_x, C_y = 0.003 µF, bandwidth = 1.6 kHz. For C_z = 0.01 µF, bandwidth = 500 Hz. For C_x, C_y, C_z = 10 µF, bandwidth = 0.5 Hz.

⁶ Self-test response changes cubically with Vs. ⁷ Turn-on time is dependent on Cx, Cy, Cz and is approximately $160 \times C_x$ or Cy or Cz + 1 ms, where Cx, Cy, Cz are in μ F.

ABSOLUTE MAXIMUM RATINGS

Table 2

ParameterRatingAcceleration (Any Axis, Unpowered) $10,000 g$ Acceleration (Any Axis, Powered) $10,000 g$ Vs $-0.3 V to +7.0 V$ All Other Pins $(COM - 0.3 V) to (V_s + 0.3 V)$ Output Short-Circuit Duration (Any Pin to Common)IndefiniteTemperature Range (Powered) $-55^{\circ}C to +125^{\circ}C$ Temperature Range (Storage) $-65^{\circ}C to +150^{\circ}C$	1 abic 2.	
Acceleration (Any Axis, Powered) $10,000 g$ V_s $-0.3 V to +7.0 V$ All Other Pins $(COM - 0.3 V) to (V_s + 0.3 V)$ Output Short-Circuit Duration (Any Pin to Common)IndefiniteTemperature Range (Powered) $-55^{\circ}C to +125^{\circ}C$	Parameter	Rating
$ \begin{array}{ll} V_{s} & -0.3 \ V \ to \ +7.0 \ V \\ All \ Other \ Pins & (COM \ -0.3 \ V) \ to \ (V_{s} \ +0.3 \ V) \\ Output \ Short-Circuit \ Duration \\ (Any \ Pin \ to \ Common) & Indefinite \\ Temperature \ Range \ (Powered) & -55^{\circ}C \ to \ +125^{\circ}C \\ \end{array} $	Acceleration (Any Axis, Unpowered)	10,000 <i>g</i>
All Other Pins(COM $- 0.3$ V) to (V ₅ $+ 0.3$ V)Output Short-Circuit Duration (Any Pin to Common)IndefiniteTemperature Range (Powered) -55° C to $+125^{\circ}$ C	Acceleration (Any Axis, Powered)	10,000 g
Output Short-Circuit Duration (Any Pin to Common)IndefiniteTemperature Range (Powered)-55°C to +125°C	Vs	–0.3 V to +7.0 V
(Any Pin to Common) Temperature Range (Powered) -55°C to +125°C	All Other Pins	$(COM - 0.3 V)$ to $(V_{s} + 0.3 V)$
	•	Indefinite
Temperature Range (Storage) -65° C to $+150^{\circ}$ C	Temperature Range (Powered)	–55°C to +125°C
	Temperature Range (Storage)	–65°C to +150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

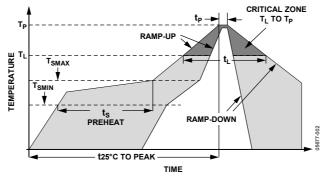


Figure 2. Recommended Soldering Profile

Table 3. Recommended Soldering Profile

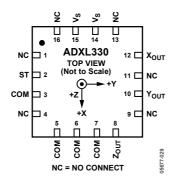
Profile Feature	Sn63/Pb37	Pb-Free	
Average Ramp Rate $(T_L \text{ to } T_P)$	3°C/s max	3°C/s max	
Preheat			
Minimum Temperature (T _{SMIN})	100°C	150°C	
Maximum Temperature (T _{SMAX})	150°C	200°C	
Time (T _{SMIN} to T _{SMAX}), ts	60 s to 120 s	60 s to 180 s	
T _{SMAX} to T _L			
Ramp-Up Rate	3°C/s max	3°C/s max	
Time Maintained Above Liquidous (TL)			
Liquidous Temperature (T _L)	183℃	217°C	
Time (t _L)	60 s to 150 s	60 s to 150 s	
Peak Temperature (T _P)	240°C + 0°C/–5°C	260°C + 0°C/–5°C	
Time within 5°C of Actual Peak Temperature (t _P)	10 s to 30 s	20 s to 40 s	
Ramp-Down Rate	6°C/s max	6°C/s max	
Time 25°C to Peak Temperature	6 minutes max	8 minutes max	

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



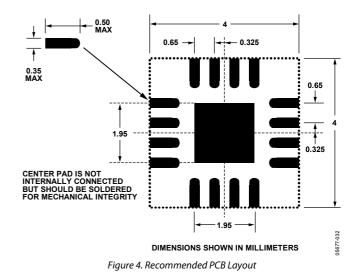


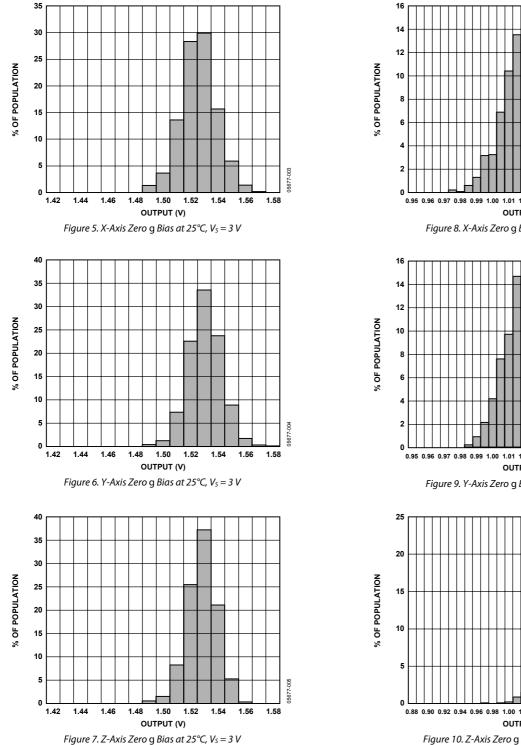
Figure 3. Pin Configuration

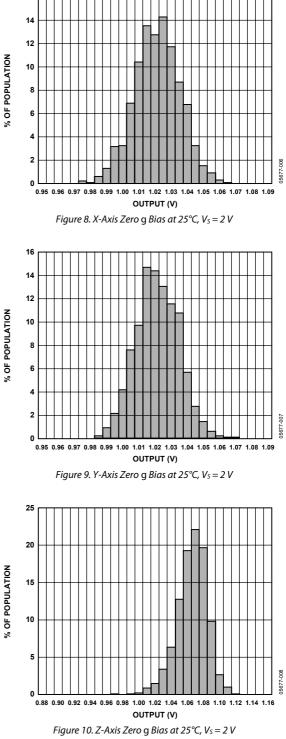
Table 4. Pin Function Descriptions

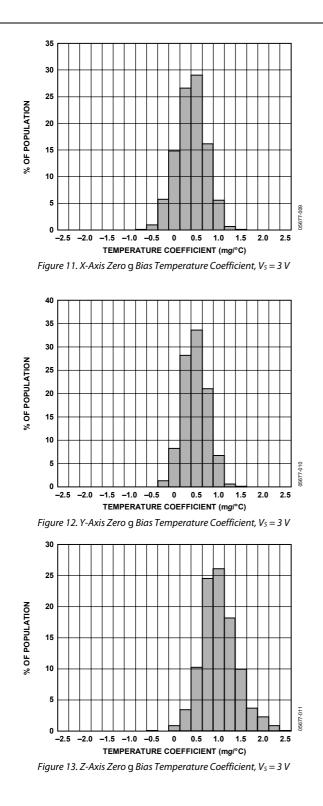
Pin No.	Mnemonic	Description
1	NC	No Connect
2	ST	Self-Test
3	COM	Common
4	NC	No Connect
5	COM	Common
6	COM	Common
7	COM	Common
8	Zout	Z Channel Output
9	NC	No Connect
10	Yout	Y Channel Output
11	NC	No Connect
12	Xout	X Channel Output
13	NC	No Connect
14	Vs	Supply Voltage (2.0 V to 3.6 V)
15	Vs	Supply Voltage (2.0 V to 3.6 V)
16	NC	No Connect

TYPICAL PERFORMANCE CHARACTERISTICS

 $\rm N>1000$ for all typical performance plots, unless otherwise noted.







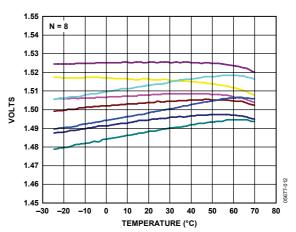


Figure 14. X-Axis Zero g Bias vs. Temperature—8 Parts Soldered to PCB

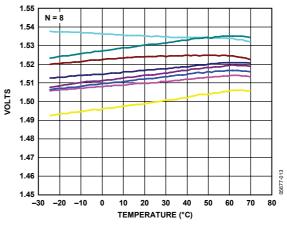


Figure 15. Y-Axis Zero g Bias vs. Temperature—8 Parts Soldered to PCB

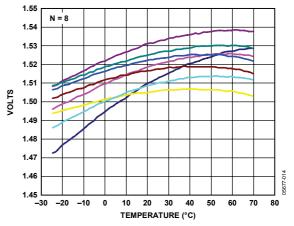
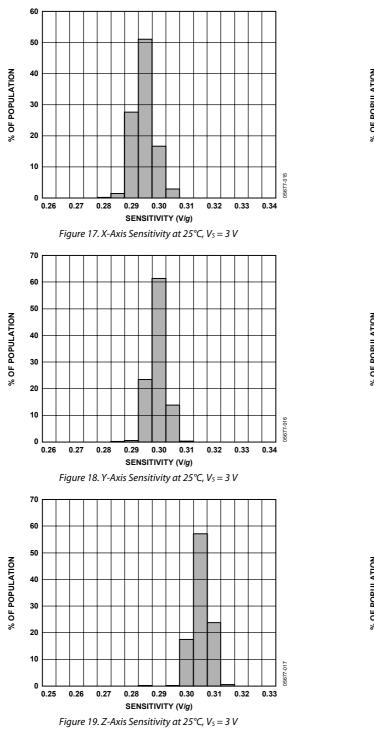
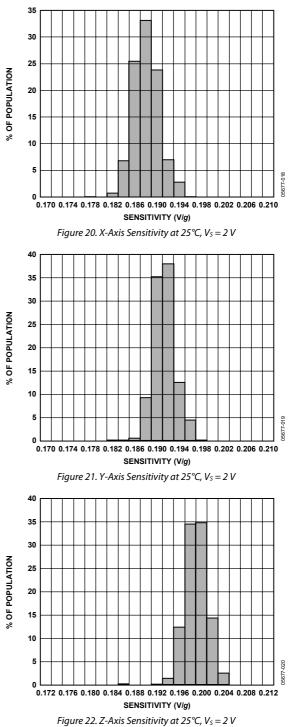
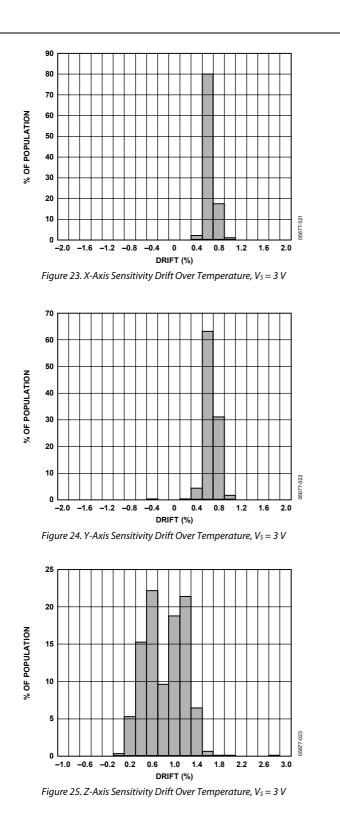
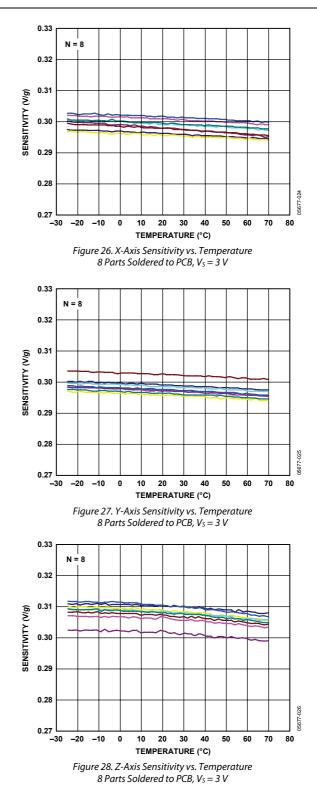


Figure 16. Z-Axis Zero g Bias vs. Temperature—8 Parts Soldered to PCB









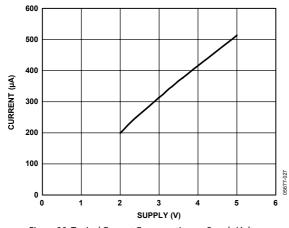


Figure 29. Typical Current Consumption vs. Supply Voltage

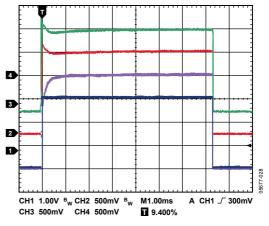


Figure 30. Typical Turn-On Time— $C_{X_r} C_{Y_r} C_Z = 0.0047 \, \mu F$, $V_S = 3 V$

THEORY OF OPERATION

The ADXL330 is a complete 3-axis acceleration measurement system on a single monolithic IC. The ADXL330 has a measurement range of $\pm 3 g$ minimum. It contains a polysilicon surface micromachined sensor and signal conditioning circuitry to implement an open-loop acceleration measurement architecture. The output signals are analog voltages that are proportional to acceleration. The accelerometer can measure the static acceleration of gravity in tilt sensing applications as well as dynamic acceleration resulting from motion, shock, or vibration.

The sensor is a polysilicon surface micromachined structure built on top of a silicon wafer. Polysilicon springs suspend the structure over the surface of the wafer and provide a resistance against acceleration forces. Deflection of the structure is measured using a differential capacitor that consists of independent fixed plates and plates attached to the moving mass. The fixed plates are driven by 180° out-of-phase square waves. Acceleration deflects the moving mass and unbalances the differential capacitor resulting in a sensor output whose amplitude is proportional to acceleration. Phase-sensitive demodulation techniques are then used to determine the magnitude and direction of the acceleration.

The demodulator output is amplified and brought off-chip through a 32 k Ω resistor. The user then sets the signal bandwidth of the device by adding a capacitor. This filtering improves measurement resolution and helps prevent aliasing.

MECHANICAL SENSOR

The ADXL330 uses a single structure for sensing the X, Y, and Z axes. As a result, the three axes sense directions are highly orthogonal with little cross axis sensitivity. Mechanical misalignment of the sensor die to the package is the chief source of cross axis sensitivity. Mechanical misalignment can, of course, be calibrated out at the system level.

PERFORMANCE

Rather than using additional temperature compensation circuitry, innovative design techniques ensure high performance is built-in to the ADXL330. As a result, there is neither quantization error nor nonmonotonic behavior, and temperature hysteresis is very low (typically less than 3 mg over the -25° C to $+70^{\circ}$ C temperature range).

Figure 14, Figure 15, and Figure 16 show the zero *g* output performance of eight parts (X-, Y-, and Z-axis) soldered to a PCB over a -25° C to $+70^{\circ}$ C temperature range.

Figure 26, Figure 27, and Figure 28 demonstrate the typical sensitivity shift over temperature for supply voltages of 3 V. This is typically better than $\pm 1\%$ over the -25° C to $+70^{\circ}$ C temperature range.

APPLICATIONS POWER SUPPLY DECOUPLING

For most applications, a single 0.1 μ F capacitor, C_{DC}, placed close to the ADXL330 supply pins adequately decouples the accelerometer from noise on the power supply. However, in applications where noise is present at the 50 kHz internal clock frequency (or any harmonic thereof), additional care in power supply bypassing is required as this noise can cause errors in acceleration measurement. If additional decoupling is needed, a 100 Ω (or smaller) resistor or ferrite bead can be inserted in the supply line. Additionally, a larger bulk bypass capacitor (1 μ F or greater) can be added in parallel to C_{DC}. Ensure that the connection from the ADXL330 ground to the power supply ground is low impedance because noise transmitted through ground has a similar effect as noise transmitted through V_s.

SETTING THE BANDWIDTH USING C_x, C_y, AND C_z

The ADXL330 has provisions for band limiting the X_{OUT} , Y_{OUT} , and Z_{OUT} pins. Capacitors must be added at these pins to implement low-pass filtering for antialiasing and noise reduction. The equation for the 3 dB bandwidth is

$$F_{-3 \text{ dB}} = 1/(2\pi(32 \text{ k}\Omega) \times C_{(X, Y, Z)})$$

or more simply

 $F_{-3 \text{ dB}} = 5 \ \mu F / C_{(X, Y, Z)}$

The tolerance of the internal resistor (R_{FILT}) typically varies as much as $\pm 15\%$ of its nominal value (32 k Ω), and the bandwidth varies accordingly. A minimum capacitance of 0.0047 μ F for C_x, C_y, and C_z is recommended in all cases.

Bandwidth (Hz)	Capacitor (µF)
1	4.7
10	0.47
50	0.10
100	0.05
200	0.027
500	0.01

Table 5. Filter Capacitor Selection, Cx, Cy, and Cz

SELF-TEST

The ST pin controls the self-test feature. When this pin is set to V_s, an electrostatic force is exerted on the accelerometer beam. The resulting movement of the beam allows the user to test if the accelerometer is functional. The typical change in output is -500 mg (corresponding to -150 mV) in the X-axis, 500 mg (or 150 mV) on the Y-axis, and -200 mg (or -60 mV) on the Z-axis. This ST pin may be left open circuit or connected to common (COM) in normal use.

Never expose the ST pin to voltages greater than V_s + 0.3 V. If this cannot be guaranteed due to the system design (for

instance, if there are multiple supply voltages), then a low V_F clamping diode between ST and V_S is recommended.

DESIGN TRADE-OFFS FOR SELECTING FILTER CHARACTERISTICS: THE NOISE/BW TRADE-OFF

The selected accelerometer bandwidth ultimately determines the measurement resolution (smallest detectable acceleration). Filtering can be used to lower the noise floor to improve the resolution of the accelerometer. Resolution is dependent on the analog filter bandwidth at X_{OUT}, Y_{OUT}, and Z_{OUT}.

The output of the ADXL330 has a typical bandwidth of greater than 500 Hz. The user must filter the signal at this point to limit aliasing errors. The analog bandwidth must be no more than half the analog-to-digital sampling frequency to minimize aliasing. The analog bandwidth can be further decreased to reduce noise and improve resolution.

The ADXL330 noise has the characteristics of white Gaussian noise, which contributes equally at all frequencies and is described in terms of $\mu g/\sqrt{Hz}$ (the noise is proportional to the square root of the accelerometer bandwidth). The user should limit bandwidth to the lowest frequency needed by the application to maximize the resolution and dynamic range of the accelerometer.

With the single-pole, roll-off characteristic, the typical noise of the ADXL330 is determined by

rms Noise = Noise Density
$$\times (\sqrt{BW \times 1.6})$$

Often, the peak value of the noise is desired. Peak-to-peak noise can only be estimated by statistical methods. Table 6 is useful for estimating the probabilities of exceeding various peak values, given the rms value.

Peak-to-Peak Value	% of Time that Noise Exceeds Nominal Peak-to-Peak Value
2 × rms	32
$4 \times rms$	4.6
6 × rms	0.27
8 × rms	0.006

USE WITH OPERATING VOLTAGES OTHER THAN 3 V

The ADXL330 is tested and specified at $V_s = 3$ V; however, it can be powered with V_s as low as 2 V or as high as 3.6 V. Note that some performance parameters change as the supply voltage is varied.

The ADXL330 output is ratiometric, therefore, the output sensitivity (or scale factor) varies proportionally to the supply voltage. At V_s = 3.6 V, the output sensitivity is typically 360 mV/g. At V_s = 2 V, the output sensitivity is typically 195 mV/g.

The zero *g* bias output is also ratiometric, so the zero *g* output is nominally equal to $V_s/2$ at all supply voltages.

The output noise is not ratiometric but is absolute in volts; therefore, the noise density decreases as the supply voltage increases. This is because the scale factor (mV/g) increases while the noise voltage remains constant. At V_s = 3.6 V, the X- and Y-axis noise density is typically 230 $\mu g/\sqrt{Hz}$, while at V_s = 2 V, the X- and Y-axis noise density is typically 350 $\mu g/\sqrt{Hz}$.

Self-test response in g is roughly proportional to the square of the supply voltage. However, when ratiometricity of sensitivity is factored in with supply voltage, the self-test response in volts is roughly proportional to the cube of the supply voltage. For example, at V_s = 3.6 V, the self-test response for the ADXL330 is approximately –275 mV for the X-axis, +275 mV for the Y-axis, and –100 mV for the Z-axis.

At $V_S = 2$ V, the self-test response is approximately -60 mV for the X-axis, +60 mV for the Y-axis, and -25 mV for the Z-axis.

The supply current decreases as the supply voltage decreases. Typical current consumption at V_s = 3.6 V is 375 µA, and typical current consumption at V_s = 2 V is 200 µA.

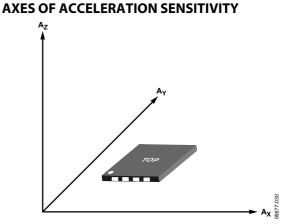


Figure 31. Axes of Acceleration Sensitivity, Corresponding Output Voltage Increases When Accelerated Along the Sensitive Axis

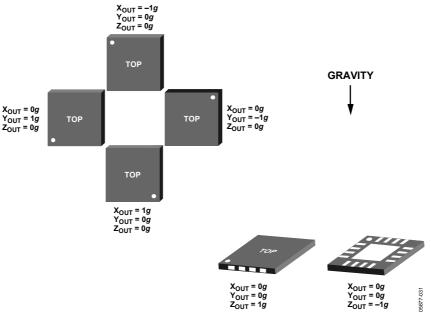
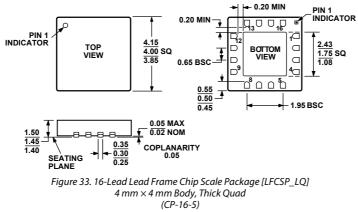


Figure 32. Output Response vs. Orientation to Gravity

OUTLINE DIMENSIONS



Dimensions shown in millimeters

ORDERING GUIDE

Model	Measurement Range	Specified Voltage	Temperature Range	Package Description	Package Option
ADXL330KCPZ ¹	±3 g	3 V	-25°C to +70°C	16-Lead LFCSP_LQ	CP-16-5
ADXL330KCPZ-RL ¹	±3 <i>g</i>	3 V	-25°C to +70°C	16-Lead LFCSP_LQ	CP-16-5
EVAL-ADXL330				Evaluation Board	

 1 Z = Pb-free part.

NOTES